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Complete if Known

Application Number	10/571,044
Filing Date	March 3, 2006
First Named Inventor	Takashi Oku
Group Art Unit	2875
Examiner Name	Mary Zettl
Attorney Docket Number	075834.00553

Sheet 1 of 1

U.S. PATENT DOCUMENTS

Examiner Initials*	Cite No. ¹	U.S. Patent Document		Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		Number	Kind Code ² (if known)			
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FOREIGN PATENT DOCUMENTS

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		Office ³	Number ⁴	Kind Code ⁵ (if known)				
	F1	JP	2001-112777		Olympus Optical Co Ltd	04/24/2001		
	F2	JP	11-038207		Dainippon Printing Co Ltd	02/12/1999		
	F3	JP	08-335044		Dainippon Printing Co Ltd	12/17/1996		
	F4	JP	08-254604		Omron Corp	10/01/1996		
	F5	JP	08-184704		Sekisui Chem Co Ltd	07/16/1996		
	F6	JP	08-062428		Dainippon Printing Co Ltd	03/08/1996		
	F7	JP	06-301021		Hitachi Ltd	10/28/1994		
	F8	JP	06-201904		Dainippon Printing Co Ltd	07/22/1994		
	F9	JP	05-061120		Kuraray Co Ltd	03/12/1993		
	F10							

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LIST FOR IDS

REFERENCE WITH "-cb" ATTACHED TO THE NUMBER HAS BEEN CITED BEFORE, REFERENCE WITHOUT THE SUFFIX WAS FIRST CITED IN THE ATTACHED OA.

SONY REF.	US SERIAL NO.	IDS TIMING
S04P1318US00	10/571044	OA (JP)

CORRESPONDING JAPANESE PATENT APPLICATION

JP	2003	-	338308	OA issued on: 2008/2/7	[HQ-CASE]
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PATENT DOCUMENT(S)					ENGLISH EQUIVALENT	
1	JPA	HEI	05 - 173134	<i>cited</i> ((JPA 1993 173134)		
2	JPA		2003 - 240921	<i>cited</i> ((JPA 2003 240921)		
3	JPA		2000 - 030515	<i>cited</i> ((JPA 2000 030515)		
4	JPA	HEI	09 - 101405	<i>cited</i> ((JPA 1997 101405)		
5	JPA	HEI	06 - 018707	<i>cited</i> ((JPA 1994 018707)		
6	JPA	HEI	06 - 222207	<i>cited</i> ((JPA 1994 222207)		
7	JPA	HEI	09 - 269418	<i>cited</i> ((JPA 1997 269418)		
8	JPA	HEI	07 - 270603	<i>cited</i> ((JPA 1995 270603)		
9	JPA	HEI	07 - 270708	<i>cited</i> ((JPA 1995 270708)		
10	JPA	HEI	08 - 335044	((JPA 1996 335044)		
11	JPA	HEI	08 - 313708	<i>cited</i> ((JPA 1996 313708)		
12	JPA	HEI	08 - 184704	((JPA 1996 184704)		
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17	JPA	HEI	05 - 061120	((JPA 1993 061120)		
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NON-PATENT DOCUMENT(S)					ENGLISH	
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